## **PRODUCT / PROCESS CHANGE INFORMATION**

| 1. PCI basic data    |  |   |
|----------------------|--|---|
| 1.1 Company          |  | STMicroelectronics International N.V  |
| 1.2 PCI No.          |  | AMS/22/13770  |
| 1.3 Title of PCI     |  | Additional Final Test platform in Muar for STGAP2SICSN (MY2514 product line). |
| 1.4 Product Category |  | PIs refer to products list.   |
| 1.5 Issue date       |  | 2022-11-17  |

| 2. PCI Team               |                          |  |
|---------------------------|--------------------------|--|
| 2.1 Contact supplier      |                          |  |
| 2.1.1 Name                | ROBERTSON HEATHER        |  |
| 2.1.2 Phone               | +1 8475853058            |  |
| 2.1.3 Email               | heather.robertson@st.com |  |
| 2.2 Change responsibility |                          |  |
| 2.2.1 Product Manager     | Domenico ARRIGO          |  |
| 2.1.2 Marketing Manager   | Fabio CHELLI             |  |
| 2.1.3 Quality Manager     | Alessandro PLATINI       |  |

| 3. Change    |  |                            |
|--------------|--|----------------------------|
| 3.1 Category | 3.2 Type of change   | 3.3 Manufacturing Location |
|              | New tester, or prober option or major HW<br>changes (ex: computer), brand or model<br>(Unknown type) | MUAR                       |

| 4. Description of change  |                                |   |
|---|--------------------------------|---|
|   | Old                            | New   |
| 4.1 Description   | ETS364 as Final Test Platform. | STS8300 and ETS364 as Final Test Platforms. |
| 4.2 Anticipated Impact on form,fit, function, quality, reliability or processability? | No Impact                      |   |

| 5. Reason / motivation for change |   |  |
|-----------------------------------|---|--|
| 5.1 Motivation                    | The additional tester is to increase capacity and to support high demand. |  |
| 5.2 Customer Benefit              | CAPACITY INCREASE   |  |

| 6. Marking of parts / traceability of change |                        |  |
|--|------------------------|--|
| 6.1 Description                              | Internal Traceability. |  |
|  |                        |  |

| 7. Timing / schedule                |              |  |
|-------------------------------------|--------------|--|
| 7.1 Date of qualification results   | 2022-11-10   |  |
| 7.2 Intended start of delivery      | 2022-12-15   |  |
| 7.3 Qualification sample available? | Upon Request |  |

| 8. Qualification / Validation                         |  |               |  |
|---|--|---------------|--|
| 8.1 Description                                       |  |               |  |
| 8.2 Qualification report and<br>qualification results |  | Issue<br>Date |  |

## 9. Attachments (additional documentations)

13770 Public product.pdf

| 10. Affected parts                              |               |                          |
|---|---------------|--------------------------|
| 10. 1 Current                                   |               | 10.2 New (if applicable) |
| 10.1.1 Customer Part No 10.1.2 Supplier Part No |               | 10.1.2 Supplier Part No  |
|   | STGAP2SICSNTR |                          |



## **Public Products List**

Publict Products are off the shelf products. They are not dedicated to specific customers, they are available through ST Sales team, or Distributors, and visible on ST.com

PCI Title : Additional Final Test platform in Muar for STGAP2SICSN (MY2514 product line).

PCI Reference : AMS/22/13770

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

| STGAP2SICSNTR | STGAP2SICSN | STGAP2SICSNCTR |
|---------------|-------------|----------------|
| STGAP2SICSNC  |             |                |

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